

ISSUE CLASSIFICATION	
Class	Subclass

U.S. **UTILITY** Patent Application

O.I.P.E.

PATENT DATE

KS
SCANNED

MS 3

Q.A.

APPLICANTS

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TITLE

Arrangements to increase structural rigidity of semiconductor package

PTO-2040
12/99

ISSUING CLASSIFICATION

ORIGINAL			CROSS REFERENCE(S)						
CLASS		SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)					
INTERNATIONAL CLASSIFICATION									

☐ Continued on Issue Slip Inside File Jacket

TERMINAL DISCLAIMER

DRAWINGS

CLAIMS ALLOWED**Sheets Drwg.**

Figs. Drwg.

Print Fig.

Total Claims:

Print Claim for O.G.

☒ The term of this patent subsequent to _____ (date) has been disclaimed.

NOTICE OF ALLOWANCE MAILED

☒ The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____

ISSUE FEE

Amount Due

Date Paid

☐ The terminal _____ months of this patent have been disclaimed.

ISSUE BATCH NUMBER

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